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(54) **RECONFIGURABLE MODULAR
OVER-RACK COMPONENT FOR MODULAR
DATA CENTERS**

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(57) **ABSTRACT**

A modular information technology component includes: a modular over-rack component; and an information technology component, in which the modular over-rack component includes a set of information technology component openings, in which the set of information technology component openings enables mounting of the information technology component into the modular over-rack component.

